

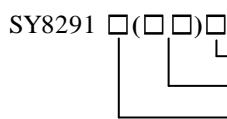
High Efficiency, 300kHz, 36V Input, 1.2A Asynchronous Step Down Regulator

General Description

The SY8291F is a high efficiency 300kHz, adaptive constant OFF time controlled asynchronous step-down DC/DC regulator capable of delivering 1.2A output current respectively. The SY8291F can operate over a wide input voltage range from 9V to 36V and integrates the main switch with very low $R_{DS(ON)}$ to minimize the conduction loss.

Low output voltage ripple and small external inductor and capacitor sizes are achieved with 300kHz switching frequency.

Ordering Information



Temperature Code
Package Code
Optional Spec Code

Ordering Number	Package type	Note
SY8291FABC	SOT23-6	--

Features

- 9-36V Input Voltage Range
- Low $R_{DS(ON)}$ for Internal N-channel Power FET: 180 mΩ
- 300kHz Switching Frequency
- Adaptive Constant OFF Time Control
- Internal Soft-start Limits the Inrush Current
- 2% 0.81V Reference
- RoHS Compliant and Halogen Free
- Compact Package: SOT23-6

Applications

- Set Top Box
- Portable TV
- Access Point Router
- DSL Modem
- LCD TV

Typical Applications

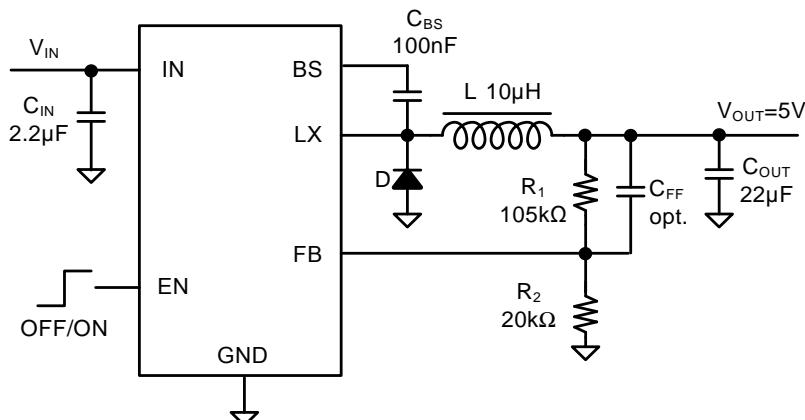
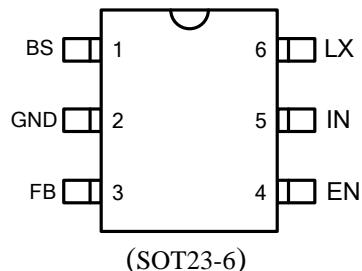


Figure1. Schematic Diagram

Pinout (top view)



Top Mark: qRxzy (Device code: qR, x=year code, y=week code, z= lot number code)

Pin Name	Pin Number	Pin Description
BS	1	Boot-strap pin. Supply high side gate driver. Decouple this pin to the LX pin with a 0.1µF ceramic capacitor.
GND	2	Ground pin.
FB	3	Output feedback pin. Connect this pin to the center point of the output resistor divider (as shown in Figure 1) to program the output voltage: $V_{OUT}=0.81\times(1+R_1/R_2)$
EN	4	Enable control. Pull high or leave this pin floating to turn on the IC, pull low to turn off the IC.
IN	5	Input pin. Decouple this pin to the GND pin with at least a 2.2µF ceramic capacitor.
LX	6	Inductor pin. Connect this pin to the switching node of the inductor.

Absolute Maximum Ratings (Note 1)

Supply Input Voltage	-0.3V to 40V
EN Voltage	-0.3V to $V_{IN}+0.6V$
FB, BS-LX Voltage	-0.3V to 3.6V
LX Voltage	-0.7V to $V_{IN} + 0.6V$
Power Dissipation, P_D @ $T_A = 25^\circ C$, SOT23-6	0.6W
Package Thermal Resistance (Note 2)	
θ_{JA}	170°C/W
θ_{JC}	130°C/W
Junction Temperature Range	-40°C to 150°C
Lead Temperature (Soldering, 10 sec.)	260°C
Storage Temperature Range	-65°C to 150°C
Dynamic LX voltage in 20ns Duration	$IN+3V$ to GND-5V

Recommended Operating Conditions (Note 3)

Supply Input Voltage	9V to 36V
Junction Temperature Range	-40°C to 125°C



Electrical Characteristics

(VIN = 12V, VOUT = 5V, L=10μH, COUT =22μF, TA = 25°C, IOUT = 0.5A unless otherwise specified)

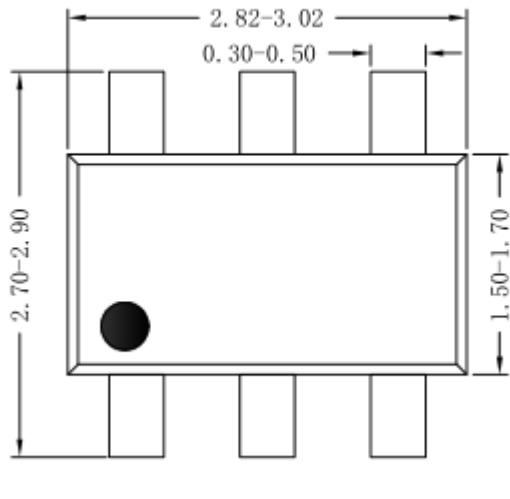
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Voltage Range	V _{IN}		9		36	V
Input UVLO Threshold	V _{UVLO}	Rising	7.5	8	8.5	V
Input UVLO Threshold		Falling	5.5	6	6.5	V
Input UVLO Hysteresis	V _{UVLO_HYS}			2		V
Quiescent Current	I _Q	I _{OUT} =0, V _{FB} =V _{REF} ×105%		160		μA
Shutdown Current	I _{SHDN}	EN=0			10	μA
Feedback Reference Voltage	V _{REF}		0.794	0.81	0.826	V
FB Input Current	I _{FB}	V _{FB} =3V	-50		50	nA
Power FET RON	R _{DSON1}			180		mΩ
Power FET Current Limit	I _{LIM}	V _{FB} =V _{REF} ×98%	1.5		2.2	A
EN Rising Threshold	V _{ENH}		1.5			V
EN Falling Threshold	V _{ENL}				0.4	V
Minimum OFF Time	t _{OFF}				100	ns
Minimum ON Time	t _{OFF}				100	ns
Soft-start Time	t _{SS}			650		μs
Oscillator Frequency	f _{OSC}		240	300	360	kHz
Thermal Shutdown Temperature	T _{SD}			150		°C
Thermal Shutdown Recovery Hysteresis	T _{HYS}			50		°C

Note 1: Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

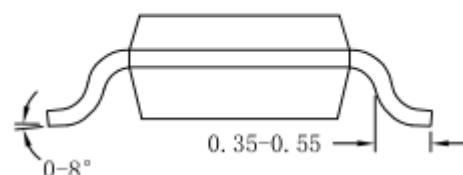
Note 2: θ_{JA} is measured in the natural convection at T_A = 25°C on a low effective single layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard.

Note 3: The device is not guaranteed to function outside its operating conditions.

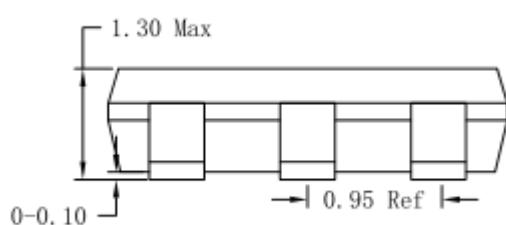
SOT23-6 Package Outline & PCB Layout Design



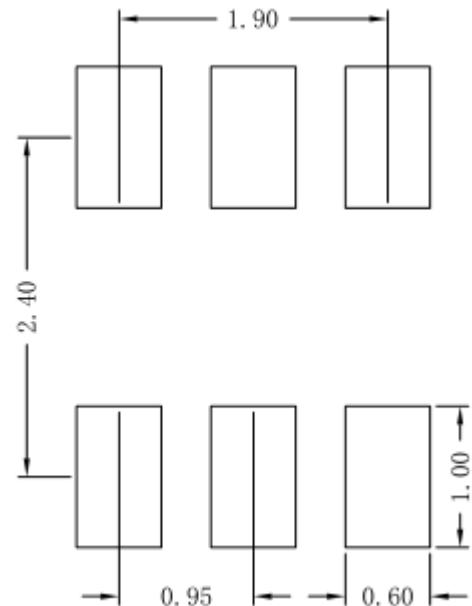
Top View



Side View



Side View

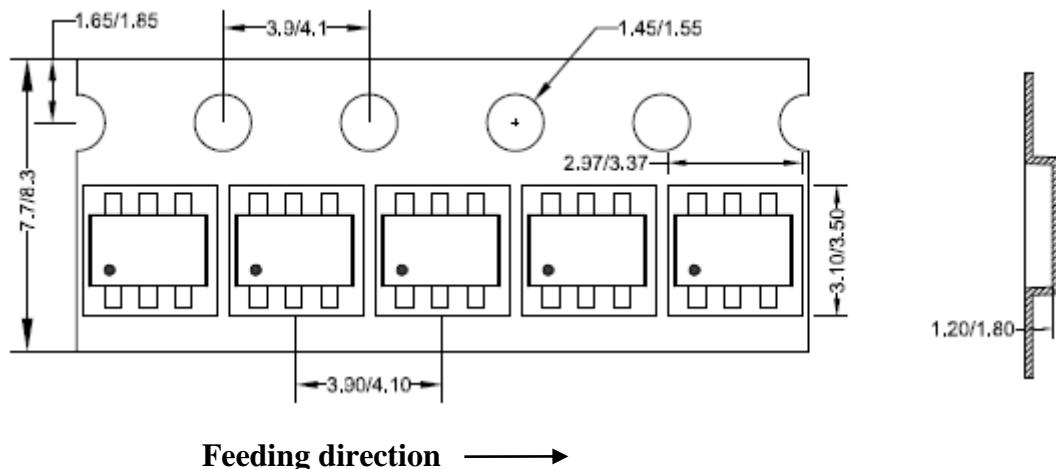


Recommended Pad Layout

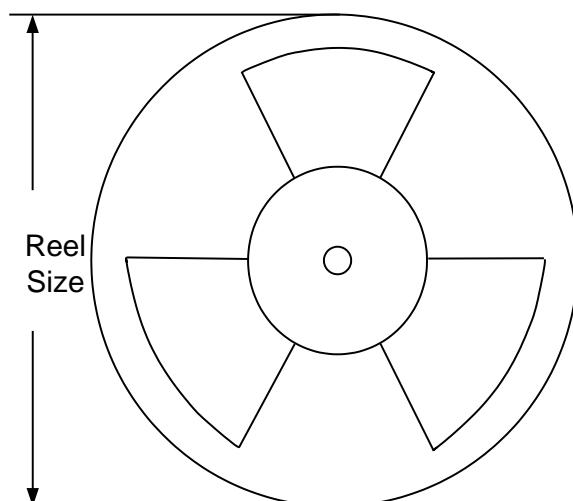
Notes: All dimension in millimeter and exclude mold flash & metal burr.

Taping & Reel Specification

1. Taping orientation for package



2. Carrier Tape & Reel specification for packages



Package type	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
SOT23-6	8	4	7"	280	160	3000

3. Others: NA

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Switching Controllers](#) category:

Click to view products by [Silergy](#) manufacturer:

Other Similar products are found below :

[NCP1218AD65R2G](#) [NCP1244BD065R2G](#) [NCP1336ADR2G](#) [NCP6153MNTWG](#) [NCP81101BMNTXG](#) [NCP81205MNTXG](#) [SJE6600](#)
[AZ7500BMTR-E1](#) [SG3845DM](#) [NCP1250BP65G](#) [NCP4204MNTXG](#) [NCP6132AMNR2G](#) [NCP81102MNTXG](#) [NCP81206MNTXG](#)
[NCP1240AD065R2G](#) [NCP1240FD065R2G](#) [NCP1361BABAYSNT1G](#) [NCP1230P100G](#) [NX2124CSTR](#) [SG2845M](#) [NCP1366BABAYDR2G](#)
[NCP81101MNTXG](#) [NCP81174NMNTXG](#) [NCP4308DMTTWG](#) [NCP4308AMTTWG](#) [NCP1366AABAYDR2G](#) [NCP1251FSN65T1G](#)
[NCP1246BLD065R2G](#) [MB39A136PFT-G-BND-ERE1](#) [NCP1256BSN100T1G](#) [LV5768V-A-TLM-E](#) [NCP1365BABCYDR2G](#)
[NCP1365AABCYDR2G](#) [NCP1246ALD065R2G](#) [AZ494AP-E1](#) [CR1510-10](#) [NCP4205MNTXG](#) [XRP6141ELTR-F](#) [RY8017](#) [LP6260SQVF](#)
[LP6298QVF](#) [ISL6121LIB](#) [ISL6225CA](#) [ISL6244HRZ](#) [ISL6268CAZ](#) [ISL6315IRZ](#) [ISL6420AIAZ-TK](#) [ISL6420AIRZ](#) [ISL6420IAZ](#)
[ISL6421ERZ](#)